

ClockWorks™ Dual 10-Gigabit/Gigabit Ethernet 62.5MHz, 125MHz, or 156.25MHz, Ultra-Low Jitter LVCMOS Clock Frequency Synthesizer

#### **General Description**

The SM840002 is a dual 10-Gigabit Ethernet and Gigabit Ethernet, 62.5MHz, 125MHz, or 156.25MHz LVCMOS clock frequency synthesizer and a member of the ClockWorks<sup>™</sup> family of devices from Micrel. It provides a low-noise timing solution for high-speed, high-accuracy synthesis of clock signals. It includes a patented RotaryWave<sup>®</sup> architecture that provides a very stable clock with very-low noise.

Power supplies of either 2.5V or 3.3V are supported, with superior jitter and phase-noise performance. The device synthesizes a 62.5MHz, 125MHz, or 156.25MHz, low-noise LVCMOS output pair for Ethernet applications. The crystal reference frequency is 25MHz.

The SM840002 is an excellent replacement for IDT FemtoClocks<sup>®</sup>, with improved waveform integrity, and jitter.

Data sheets and support documentation can be found on Micrel's web site at: <u>www.micrel.com</u>.

#### **Features**

- Generates two LVCMOS outputs
- Operating supply modes:
  - Core/Output
  - 3.3V/3.3V, 2.5V/2.5V
- Typical phase jitter @156.25MHz~64 fs (1.875MHz – 20MHz)
- Crystal frequency: 25MHz
- 62.5MHz, 125MHz, or 156.25MHz output frequency
- Output Skew: 12ps (maximum)
- Phase Noise @ 156.25MHz:
  - 1KHz: –126dBc/Hz
  - 10KHz: –130dBc/Hz
  - 100KHz: –126dBc/Hz
  - 1MHz: –139dBc/Hz
  - 10MHz: –165dBc/Hz
  - 20MHz: –166/dBc/Hz
- Temperature range: -40°C to +75°C
- Green-, RoHS-, and PFOS-compliant
- Available in 16-pin TSSOP

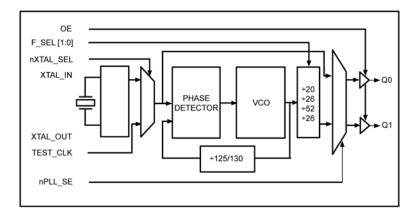
#### **Applications**

- Gigabit Ethernet
- 10-Gigabit Ethernet

ClockWorks is a trademark of Micrel, Inc. RotaryWave is a registered trademark of Multigig, Inc. FemtoClocks is a registered trademark of IDT, Inc.

Micrel Inc. • 2180 Fortune Drive • San Jose, CA 95131 • USA • tel +1 (408) 944-0800 • fax + 1 (408) 474-1000 • http://www.micrel.com

# **Block Diagram**



# Ordering Information<sup>(1)</sup>

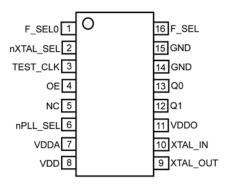
| Part Number                  | Package Type | Operating Range | Package Marking |
|------------------------------|--------------|-----------------|-----------------|
| SM840002KA                   | K-16         | –40°C to +75°C  | 840002          |
| SM840002KA TR <sup>(2)</sup> | K-16         | –40°C to +75°C  | 840002          |

#### Notes:

1. Devices are Green-, RoHS-, and PFOS-compliant.

2. Tape and Reel.

#### **Pin Configuration**





## **Pin Description**

| Pin Number | Pin Name         | Туре | Level        | Pin Function  |
|------------|------------------|------|--------------|---|
| 1          | F_SEL0           | I    | Pull-Up      | Frequency Select Pin. LVCMOS interface levels.  |
| 2          | nXTAL_SEL        | I    | Pull-Down    | Selects between XTAL and TEST_CLK Reference Input. When HIGH, selects TEST_CLK. When LOW, selects XTAL inputs. LVCMOS interface levels.   |
| 3          | TEST_CLK         | I    | Pull-Down    | Single-Ended LVCMOS Clock Input.  |
| 4          | OE               | I    | Pull-Up      | Output Enable. When HIGH, the outputs are active. When LOW, the outputs are in a high impedance state. LVCMOS interface levels.           |
| 5          | NC               |      |              | No Connect.   |
| 6          | nPLL_SEL         | I    | Pull-Down    | Selects between the VCO reference and the VCO Output. When LOW, the output is driven from the VCO output. When HIGH, the PLL is bypassed. |
| 7          | V <sub>DDA</sub> | Р    |              | 2.5V or 3.3V Output Power Supply. No filter resistor needed.  |
| 8          | V <sub>DD</sub>  | Р    |              | 2.5V or 3.3V Output Power Supply.   |
| 9          | XTAL_OUT         | 0    | 12pF Crystal | Crystal Reference Output, no load caps needed.  |
| 10         | XTAL_IN          | I    | 12pF Crystal | Crystal Reference Input, no load caps needed.   |
| 11         | V <sub>DDO</sub> | Р    |              | 2.5V or 3.3V Output Power Supply.   |
| 12         | Q1               | 0    | LVCMOS       | Single-Ended Output Clock.  |
| 13         | Q0               | 0    | LVCMOS       | Single-Ended Output Clock.  |
| 14         | GND              | Р    |              | Ground.   |
| 15         | GND              | Р    |              | Ground.   |
| 16         | F_SEL1           | I    | Pull-up      | Frequency Select Pin. LVCMOS interface levels.  |

# Configuring the SM840002

| Xtal Frequency (MHz) | F_SEL1 | F_SEL0 | M Divider | N Divider | Output Frequency (MHz) |
|----------------------|--------|--------|-----------|-----------|------------------------|
| 25                   | 0      | 0      | 125       | 20        | 156.25                 |
| 25                   | 0      | 1      | 130       | 26        | 125                    |
| 25                   | 1      | 0      | 130       | 52        | 62.5                   |
| 25                   | 1      | 1      | 130       | 26        | 125                    |

## Absolute Maximum Ratings<sup>(1)</sup>

| Supply Voltage (V <sub>DD</sub> )     | +4.6V                           |
|---------------------------------------|---------------------------------|
| Input Voltage (V <sub>IN</sub> )      | -0.50V to V <sub>DD</sub> +0.5V |
| Output Voltage (V <sub>OUT</sub> )    | -0.50V to V <sub>DD</sub> +0.5V |
| Lead Temperature (soldering, 20sec.). |                                 |
| Storage Temperature (T <sub>s</sub> ) |                                 |

## **Operating Ratings**<sup>(2)</sup>

| Supply Voltage (V <sub>DDO</sub> )                   | +2.375V to +3.465V |
|--|--------------------|
| Supply Voltage (V <sub>DD</sub> , V <sub>DDA</sub> ) | +2.375V to +3.465V |
| Ambient Temperature (T <sub>A</sub> )                | 40°C to +75°C      |
| Junction Thermal Resistance                          |                    |
| TSSOP (θ <sub>JA</sub> )(Still Air)                  | 127°C/W            |

## DC Electrical Characteristics<sup>(3)</sup>

 $V_{DDA} = V_{DD} = 2.5V \pm 5\%$ ,  $V_{DDO} = 2.5V \pm 5\%$ ,  $T_A = -40^{\circ}C$  to +75°C, unless noted.

| Symbol           | Parameter             | Condition | Min.  | Тур. | Max.  | Units |
|------------------|-----------------------|-----------|-------|------|-------|-------|
| V <sub>DD</sub>  | Core Supply Voltage   |           | 2.375 | 2.50 | 2.625 | V     |
| $V_{\text{DDA}}$ | Analog Supply Voltage |           | 2.375 | 2.50 | 2.625 | V     |
| V <sub>DDO</sub> | Output Supply Voltage |           | 2.375 | 2.50 | 2.625 | V     |
| I <sub>DD</sub>  | Core Supply Current   |           |       | 0.1  | 1     | mA    |
| I <sub>DDA</sub> | Analog Supply Current |           |       | 48   | 55    | mA    |
| I <sub>DDO</sub> | Output Supply Current | No Load   |       | 15   | 23    | mA    |

 $V_{\text{DDA}}$  =  $V_{\text{DD}}$  = 3.3V ±5%,  $V_{\text{DDO}}$  = 3.3V ±5%,  $T_{\text{A}}$  = –40°C to +75°C, unless noted.

| Symbol           | Parameter             | Condition | Min.  | Тур. | Max.  | Units |
|------------------|-----------------------|-----------|-------|------|-------|-------|
| V <sub>DD</sub>  | Core Supply Voltage   |           | 3.135 | 3.30 | 3.465 | V     |
| V <sub>DDA</sub> | Analog Supply Voltage |           | 3.135 | 3.30 | 3.465 | V     |
| V <sub>DDO</sub> | Output Supply Voltage |           | 3.135 | 3.30 | 3.465 | V     |
| I <sub>DD</sub>  | Core Supply Current   |           |       | 0.1  | 1     |       |
| I <sub>DDA</sub> | Analog Supply Current |           |       | 49   | 55    | mA    |
| I <sub>DDO</sub> | Power Supply Current  | No Load   |       | 25   | 32    | mA    |

Notes:

1. Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

4

2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.

3. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

# LVCMOS DC Electrical Characteristics<sup>(3)</sup>

 $V_{DDA}$  =  $V_{DD}$  =2.5V or 3.3V ±5%,  $V_{DDO}$  = 2.5V or 3.3V ±5%,  $T_A$  = -40°C to +75°C, unless noted.

| Symbol          | Parameter           |                                      | Condition  | Min.  | Тур. | Max.                  | Units |
|-----------------|---------------------|--------------------------------------|--|-------|------|-----------------------|-------|
| V <sub>IH</sub> | Input HIGH Voltage  |                                      | out HIGH Voltage   | 2     | 2    | V <sub>DD</sub> + 0.3 | V     |
| VIL             | Input LOW Voltage   |                                      |  | -0.30 |      | 0.80                  | V     |
|                 |                     | OE, F_SEL0, F_SEL1                   | V <sub>DD</sub> = V <sub>IN</sub> =3.465V<br>or 2.625V     |       |      | 5                     | μA    |
| I <sub>IH</sub> | Input HIGH Current  | nPLL_SEL, MR,<br>nXTAL_SEL, TEST_CLK | V <sub>DD</sub> = V <sub>IN</sub> =3.465V<br>or 2.625V     |       |      | 150                   | μA    |
|                 |                     | OE, F_SEL0, F_SEL1                   | V <sub>DD</sub> = 3.465V or 2.625V<br>V <sub>IN</sub> = 0V | -150  |      |                       | μA    |
| l <sub>IL</sub> | Input LOW Current   | nPLL_SEL, MR,<br>nXTAL_SEL, TEST_CLK | V <sub>DD</sub> = 3.465V or 2.625V<br>V <sub>IN</sub> = 0V | -5    |      |                       | μA    |
| M               | Output HIGH Voltage | $V_{DDO} = 3.3V \pm 5\%$             | V <sub>DDO</sub> = 3.3V ±5%                                | 2.6   |      |                       | V     |
| V <sub>OH</sub> |                     |                                      | V <sub>DDO</sub> = 2.5V ±5%                                | 1.8   |      |                       | V     |
| V <sub>OL</sub> | Output LOW Voltage  | 4)                                   | V <sub>DDO</sub> = 3.3V ±5% or 2.5V<br>±5%                 |       |      | 0.5                   | V     |

## AC Electrical Characteristics<sup>(5)</sup>

 $V_{DDA} = V_{DD} = 2.5V \text{ or } 3.3V \pm 5\%, V_{DDO} = 2.5V \text{ or } 3.3V \pm 5\%, T_A = -40^{\circ}C \text{ to } +75^{\circ}C, \text{ unless noted.}$ 

| Symbol                         | Parameter                  | Condition       | Min. | Тур.   | Max. | Units |
|--------------------------------|----------------------------|-----------------|------|--------|------|-------|
| Fout                           | Output Frequency           | F_SEL[1:0] = 00 |      | 156.25 |      | MHz   |
| Fout                           | Output Frequency           | F_SEL[1:0] = 01 |      | 125    |      | MHz   |
| Fout                           | Output Frequency           | F_SEL[1:0] = 10 |      | 62.5   |      | MHz   |
| Fout                           | Output Frequency           | F_SEL[1:0] = 11 |      | 125    |      | MHz   |
| t <sub>skew</sub>              | Output Skew <sup>(6)</sup> |                 |      |        | 12   | ps    |
| t <sub>JITTER</sub>            | RMS Phase Jitter           | 156.25MHz       |      | 0.064  |      | ps    |
| t <sub>JITTER</sub>            | RMS Phase Jitter           | 125MHz          |      | 0.065  |      | ps    |
| <b>t</b> JITTER                | RMS Phase Jitter           | 62.5MHz         |      | 0.077  |      | ps    |
| t <sub>R</sub> /t <sub>F</sub> | Output Rise/ Fall Time     | 20% to 80%      | 100  |        | 350  | ps    |
| O <sub>DC</sub>                | Output Duty Cycle          |                 | 48   | 50     | 52   | %     |

Notes:

4. Outputs terminated with 50 $\Omega$  to V<sub>DD</sub>/2. See Parameters measurements 3.3V load test circuit.

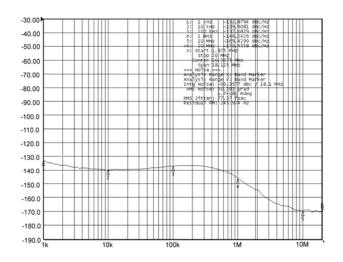
5. The circuit is designed to meet the AC specifications shown in the above table(s) after thermal equilibrium has been established.

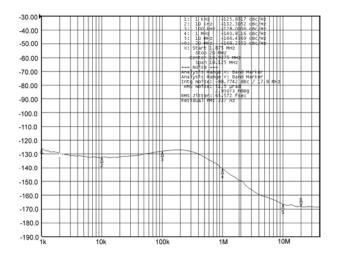
6. Defined as skew between outputs at the same supply voltage and with equal load conditions; Measured at the output differential crossing points.

5

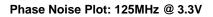
#### **Crystal Characteristics**

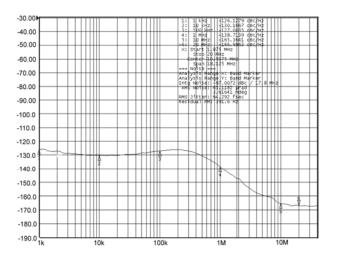
| Parameter                          | Condition | Min. | Тур.            | Max.            | Units |
|------------------------------------|-----------|------|-----------------|-----------------|-------|
| Mode of Oscillation                | 12pF Load |      | Fundamental, Pa | rallel Resonant |       |
| Frequency                          |           |      | 25              |                 | MHz   |
| Equivalent Series Resistance (ESR) |           |      |                 | 50              | Ω     |
| Shunt Capacitor, C0                |           |      | 3               | 7               | pF    |
| Correlation Drive Level            |           |      | 100             | 300             | uW    |





Phase Noise Plot: 62.5MHz @ 3.3V





Phase Noise Plot: 156.25MHz @ 3.3V

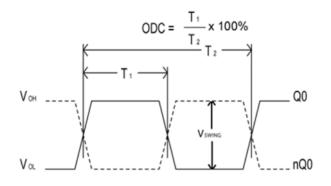


Figure 1. Duty Cycle Timing

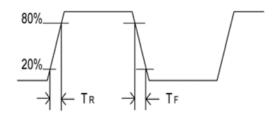
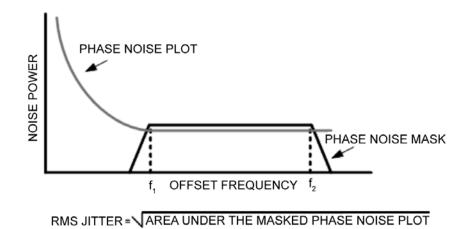
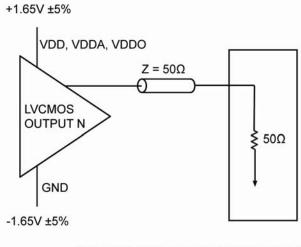


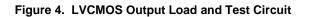
Figure 2. All Outputs Rise/Fall Time

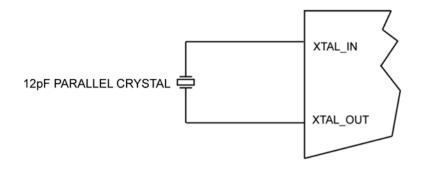






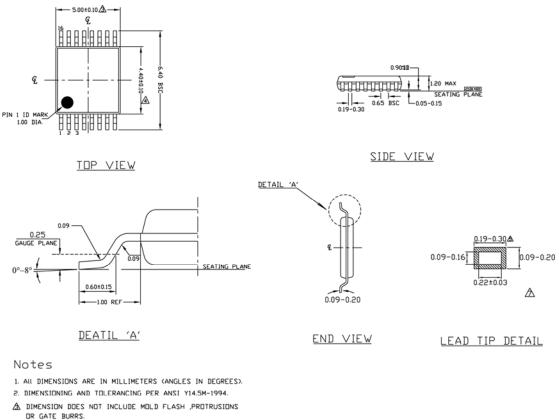
(OUTPUT LOAD AC TEST CIRCUIT, 3.3V)







#### **Package Information**



- A DIMENSION DOES NOT INCLUDE INTERNAL FLASH OR PROTRUSION.
- ▲ DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION.
- ▲ CROSS SECTION TO BE DETERMINED AT 0.10 TO 0.25MM FROM THE LEAD TIP.

16-Pin TSSOP (K-16)

#### MICREL, INC. 2180 FORTUNE DRIVE SAN JOSE, CA 95131 USA

TEL +1 (408) 944-0800 FAX +1 (408) 474-1000 WEB http://www.micrel.com

Micrel makes no representations or warranties with respect to the accuracy or completeness of the information furnished in this data sheet. This information is not intended as a warranty and Micrel does not assume responsibility for its use. Micrel reserves the right to change circuitry, specifications and descriptions at any time without notice. No license, whether express, implied, arising by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Micrel's terms and conditions of sale for such products, Micrel assumes no liability whatsoever, and Micrel disclaims any express or implied warranty relating to the sale and/or use of Micrel products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right

Micrel Products are not designed or authorized for use as components in life support appliances, devices or systems where malfunction of a product can reasonably be expected to result in personal injury. Life support devices or systems are devices or systems that (a) are intended for surgical implant into the body or (b) support or sustain life, and whose failure to perform can be reasonably expected to result in a significant injury to the user. A Purchaser's use or sale of Micrel Products for use in life support appliances, devices or systems is a Purchaser's own risk and Purchaser agrees to fully indemnify Micrel for any damages resulting from such use or sale.

© 2010 Micrel, Incorporated.